

NB7VQ572M

1.8V / 2.5V / 3.3V Differential 4:1 Mux w/Input Equalizer to 1:2 CML Clock/Data Fanout / Translator

Multi-Level Inputs w/ Internal Termination

Description

The NB7VQ572M is a high performance differential 4:1 Clock / Data input multiplexer and a 1:2 CML Clock / Data fanout buffer that operates up to 7 GHz / 10 Gbps respectively with a 1.8 V, 2.5 V, or 3.3 V power supply.

Each IN_x / $\overline{IN}_x$ input pair incorporates a fixed Equalizer Receiver, which when placed in series with a Data path, will enhance the degraded signal transmitted across an FR4 backplane or cable interconnect. For applications that do not require Equalization, consider the NB7V572M, which is pin-compatible to the NB7VQ572M.

The differential Clock / Data inputs have internal 50 Ω termination resistors and will accept differential LVPECL, CML, or LVDS logic levels. The NB7VQ572M incorporates a pair of Select pins that will choose one of four differential inputs and will produce two identical CML output copies of Clock or Data.

As such, the NB7VQ572M is ideal for SONET, GigE, Fiber Channel, Backplane and other Clock/Data distribution applications. The two differential CML outputs will swing 400 mV when externally loaded and terminated with a 50 Ω resistor to V_{CC} and are optimized for low skew and minimal jitter.

The NB7VQ572M is offered in a low profile 5x5 mm 32-pin QFN Pb-Free package. Application notes, models, and support documentation are available at www.onsemi.com. The NB7VQ572M is a member of the GigaComm™ family of high performance clock products.

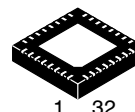
Features

- Input Data Rate > 10 Gb/s Typical
- Data Dependent Jitter < 10 ps
- Maximum Input Clock Frequency > 6 GHz Typical
- Random Clock Jitter < 0.8 ps RMS
- Low Skew 1:2 CML Outputs, < 15 ps max
- 4:1 Multi-Level Mux Inputs, accepts LVPECL, CML, LVDS
- 175 ps Typical Propagation Delay
- 45 ps Typical Rise and Fall Times
- Differential CML Outputs, 400 mV Peak-to-Peak, Typical
- Operating Range: V_{CC} = 1.71 V to 3.6 V with GND = 0 V
- Internal 50 Ω Input Termination Resistors
- VREFAC Reference Output
- QFN-32 Package, 5mm x 5mm, Pb-Free
- -40°C to +85°C Ambient Operating Temperature
- These are Pb-Free Devices



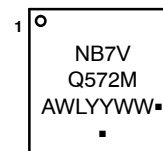
ON Semiconductor®

<http://onsemi.com>



QFN32
MN SUFFIX
CASE 488AM

MARKING DIAGRAM



A	= Assembly Location
WL	= Wafer Lot
YY	= Year
WW	= Work Week
▪	= Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information on page 10 of this data sheet.

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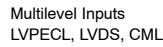


Figure 1. Simplified Block Diagram



Figure 2. Pinout: QFN-32 (Top View)

Table 1. INPUT SELECT FUNCTION TABLE

SEL1*	SEL0*	Clock / Data Input Selected
0	0	IN0 Input Selected
0	1	IN1 Input Selected
1	0	IN2 Input Selected
1	1	IN3 Input Selected

*Defaults HIGH when left open.

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Table 2. PIN DESCRIPTION

Pin Number	Pin Name	I/O	Pin Description
1, 4 5, 8 25, 28 29, 32	IN0, $\overline{\text{IN0}}$ IN1, $\overline{\text{IN1}}$ IN2, $\overline{\text{IN2}}$ IN3, $\overline{\text{IN3}}$	LVPECL, CML, LVDS Input	Noninverted, Inverted, Differential Clock or Data Inputs
2, 6 26, 30	VT0, VT1 VT2, VT3		Internal 100 Ω Center-tapped Termination Pin for INx / $\overline{\text{INx}}$
15 18	SEL0 SEL1	LVTTL/LVCMOS Input	Input Select pins, default HIGH when left open through a 94 k Ω pullup resistor. Input logic threshold is $V_{CC}/2$. See Select Function, Table 1.
14, 19	NC	–	No Connect
10, 13, 16 17, 20, 23	V _{CC}	–	Positive Supply Voltage.
11, 12 21, 22	$\overline{\text{Q0}}$, Q0 $\overline{\text{Q1}}$, Q1	CML Output	Inverted, Non-inverted Differential Outputs.
9, 24	GND		Negative Supply Voltage
3 7 27 31	VREFAC0 VREFAC1 VREFAC2 VREFAC3	–	Output Voltage Reference for Capacitor-Coupled Inputs
–	EP	–	The Exposed Pad (EP) on the QFN-32 package bottom is thermally connected to the die for improved heat transfer out of package. The exposed pad must be attached to a heat-sinking conduit. The pad is electrically connected to the die, and must be electrically connected to GND.

1. In the differential configuration when the input termination pins (VT0, VT1, VT2, VT3) are connected to a common termination voltage or left open, and if no signal is applied on INx/ $\overline{\text{INx}}$ input, then the device will be susceptible to self-oscillation.
2. All V_{CC}, and GND pins must be externally connected to a power supply for proper operation.

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Table 3. ATTRIBUTES

Characteristics	Value
ESD Protection Human Body Model Machine Model	> 2 kV > 200 V
R _{PU} – SELx Input Pullup Resistor	28 kΩ
Moisture Sensitivity (Note 3) QFN–32	Level 1
Flammability Rating Oxygen Index: 28 to 34	UL 94 V–0 @ 0.125 in
Transistor Count	252
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test	

3. For additional information, see Application Note AND8003/D.

Table 4. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V _{CC}	Positive Power Supply	GND = 0 V		4.0	V
V _{IN}	Positive Input Voltage	GND = 0 V		–0.5 to V _{CC} +0.5	V
V _{INPP}	Differential Input Voltage I _N – I _N			1.89	V
I _{out}	Output Current Through R _T (50 Ω Resistor)			± 40	mA
I _{IN}	Input current Through RT (50 Ω Resistor)			± 40	mA
I _{VREFAC}	V _{REFAC} Sink or Source Current			± 1.5	mA
T _A	Operating Temperature Range			–40 to +85	°C
T _{stg}	Storage Temperature Range			–65 to +150	°C
θ _{JA}	Thermal Resistance (Junction–to–Ambient) (Note 4)	0 lfpm 500 lfpm	QFN–32 QFN–32	31 27	°C/W °C/W
θ _{JC}	Thermal Resistance (Junction–to–Case) (Note 4)		QFN–32	12	°C/W
T _{sol}	Wave Solder	≤ 20 sec		265	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

4. JEDEC standard multilayer board – 2S2P (2 signal, 2 power) with 8 filled thermal vias under exposed pad.

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Table 5. DC CHARACTERISTICS CML OUTPUT $V_{CC} = 1.71 \text{ V to } 3.6 \text{ V}$, $GND = 0 \text{ V}$, $T_A = -40^\circ\text{C to } +85^\circ\text{C}$ (Note 5)

Symbol	Characteristic		Min	Typ	Max	Unit
POWER SUPPLY						
V _{CC}	Power Supply Voltage	V _{CC} = 3.3 V V _{CC} = 2.5 V V _{CC} = 1.8 V	3.0 2.375 1.71	3.3 2.5 1.8	3.6 2.625 1.89	V
I _{CC}	Power Supply Current for V _{CC} (Inputs and Outputs Open)	V _{CC} = 3.3 V V _{CC} = 2.5 V V _{CC} = 1.8 V		130 120 100	160 145 120	mA
CML OUTPUTS (Note 6)						
V _{OH}	Output HIGH Voltage	V _{CC} = 3.3 V V _{CC} = 2.5 V V _{CC} = 1.8 V	V _{CC} – 30 3270 2470 1770	V _{CC} – 5 3295 2495 1795	V _{CC} 3300 2500 1800	mV
V _{OL}	Output LOW Voltage	V _{CC} = 3.3 V V _{CC} = 2.5 V V _{CC} = 1.8 V	V _{CC} – 550 2675 1875	V _{CC} – 450 2825 2025 1325	V _{CC} – 350 2975 2175 1475	mV
V _{OL}	Output LOW Voltage	V _{CC} = 3.3 V V _{CC} = 2.5 V V _{CC} = 1.8 V	V _{CC} – 625 2675 V _{CC} – 600 1900 V _{CC} – 550 1250	V _{CC} – 475 2825 V _{CC} – 475 2025 V _{CC} – 450 1350	V _{CC} – 325 2975 V _{CC} – 350 2150 V _{CC} – 350 1450	mV
DIFFERENTIAL CLOCK INPUTS DRIVEN SINGLE-ENDED (Figures 7 and 8) (Note 7)						
V _{IH}	Single-ended Input HIGH Voltage		V _{th} + 100		V _{CC}	mV
V _{IL}	Single-ended Input LOW Voltage		GND		V _{th} – 100	mV
V _{th}	Input Threshold Reference Voltage Range (Note 8)		1100		V _{CC} – 100	mV
V _{ISE}	Single-ended Input Voltage (V _{IH} – V _{IL})		200		1200	mV
VREFAC						
V _{REFAC}	Output Reference Voltage (100 μA Load)	V _{CC} = 3.3 V V _{CC} = 2.5 V V _{CC} = 1.8 V	V _{CC} – 800 V _{CC} – 750 1050	V _{CC} – 625 V _{CC} – 575 V _{CC} – 525	V _{CC} – 500 V _{CC} – 450 V _{CC} – 400	mV
DIFFERENTIAL INPUTS DRIVEN DIFFERENTIALLY (Figures 9 and 10) (Note 9)						
V _{IHD}	Differential Input HIGH Voltage (I _N , I _N)		1200		V _{CC}	mV
V _{ILD}	Differential Input LOW Voltage (I _N , I _N)		0		V _{IHD} – 100	mV
V _{ID}	Differential Input Voltage (I _N , I _N) (V _{IHD} – V _{ILD})		100		1200	mV
V _{CMR}	Input Common Mode Range (Differential Configuration, Note 10) (Figure 11)		1150		V _{CC} – 50	mV
I _{IH}	Input HIGH Current I _N / I _N (V _{TIN} /V _{TIN} Open)		–150		150	μA
I _{IL}	Input LOW Current I _N / I _N (V _{TIN} /V _{TIN} Open)		–150		150	μA
CONTROL INPUT (SELx Pin)						
V _{IH}	Input HIGH Voltage for Control Pin		V _{CC} x 0.65		V _{CC}	V
V _{IL}	Input LOW Voltage for Control Pin		GND		V _{CC} x 0.35	V
I _{IH}	Input HIGH Current		–150		150	μA
I _{IL}	Input LOW Current		–150		150	μA
TERMINATION RESISTORS						
R _{TIN}	Internal Input Termination Resistor (Measured from I _{Nx} to V _{Tx})		45	50	55	Ω
R _{TOUT}	Internal Output Termination Resistor		45	50	55	Ω

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- Input and Output parameters vary 1:1 with V_{CC} .
- CML outputs loaded with 50 Ω to V_{CC} for proper operation.
- V_{th} , V_{IH} , V_{IL} , and V_{ISE} parameters must be complied with simultaneously.
- V_{th} is applied to the complementary input when operating in single-ended mode.
- V_{IHD} , V_{ILD} , V_{ID} and V_{CMR} parameters must be complied with simultaneously.
- V_{CMR} min varies 1:1 with GND, V_{CMR} max varies 1:1 with V_{CC} . The V_{CMR} range is referenced to the most positive side of the differential input signal.

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Table 6. AC CHARACTERISTICS $V_{CC} = 1.71\text{ V to }3.6\text{ V}$, $GND = 0\text{ V}$, $T_A = -40^\circ\text{C to }+85^\circ\text{C}$ (Note 11)

Symbol	Characteristic	Min	Typ	Max	Unit
f_{MAX}	Maximum Input Clock Frequency $V_{OUT} \geq 200\text{ mV}$	6	7		GHz
$f_{DATAMAX}$	Maximum Operating Data Rate NRZ, (PRBS23)	10	11		Gbps
f_{SEL}	Maximum Toggle Frequency, SELx	4	10		MHz
V_{OUTPP}	Output Voltage Amplitude (@ $V_{INPPmin}$) (Note 12) (Figure 12) $f_{in} \leq 5\text{ GHz}$	250	400		mV
t_{PLH} , t_{PHL}	Propagation Delay to Differential Outputs Measured at Differential Crosspoint @ 1 GHz INx/INx to Qx/Qx @ 50 MHz SELx to Qx	100	175 7	250 20	ps ns
$t_{PD\ Tempco}$	Differential Propagation Delay Temperature Coefficient		50		$\Delta fs/^\circ C$
t_{skew}	Output – Output skew (within device) (Note 13) Device – Device skew ($t_{pdmax} - t_{pdmin}$)		0 30	15 100	ps
t_{DC}	Output Clock Duty Cycle (Reference Duty Cycle = 50%) $f_{IN} \leq 5\text{ GHz}$	45	50	55	%
Φ_N	Phase Noise, $f_{in} = 1\text{ GHz}$ 10 kHz 100 kHz 1 MHz 10 MHz 20 MHz 40 MHz		-134 -136 -149 -149 -149 -149		dBc
$t_{J\Phi N}$	Integrated Phase Jitter (Figure TBD) $f_{in} = 1\text{ GHz}$, 12 kHz – 20 MHz Offset (RMS)		35		fs
t_{JITTER}	Random Clock Jitter, RJ (Note 14) Deterministic Jitter, DJ (Note 15) $f_{in} \leq 6\text{ GHz}$ $f_{in} \leq 10\text{ Gbps}$ (12" FR4)		0.2	0.8 10	ps RMS ps pk-pk
	Crosstalk Induced Jitter (Adjacent Channel) (Note 17)			0.7	ps RMS
V_{INPP}	Input Voltage Swing (Differential Configuration) (Note 16)	100		1200	mV
t_r , t_f	Output Rise/Falltimes @ 1 GHz; (20% – 80%), $V_{IN} = 400\text{ mV}$ Qx, Qx	25	45	65	ps

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

11. Measured using a 150 mVpk-pk source, 50% duty cycle clock source. All output loading with external 50 Ω to V_{CC} . Input edge rates 40 ps (20% – 80%).

12. Output voltage swing is a single-ended measurement operating in differential mode.

13. Skew is measured between outputs under identical transitions and conditions. Duty cycle skew is defined only for differential operation when the delays are measured from crosspoint of the inputs to the crosspoint of the outputs.

14. Additive RMS jitter with 50% duty cycle clock signal.

15. Additive Peak-to-Peak data dependent jitter with input NRZ data at PRBS23.

16. Input voltage swing is a single-ended measurement operating in differential mode.

17. Crosstalk is measured at the output while applying two similar clock frequencies that are asynchronous with respect to each other at the inputs.

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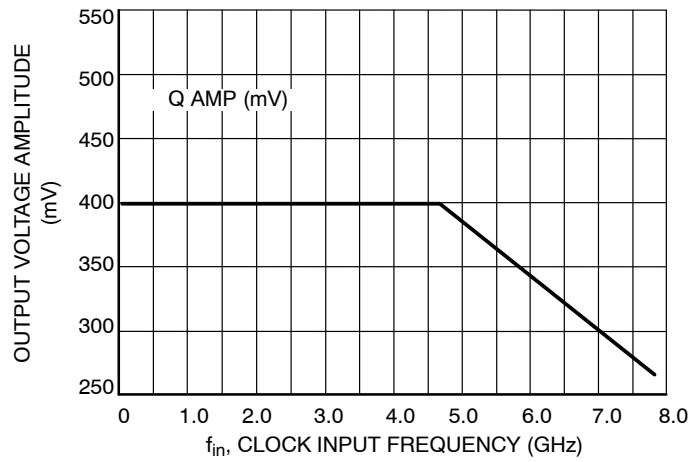


Figure 3. Clock Output Voltage Amplitude (V_{OUTPP}) vs. Input Frequency (f_{in}) at Ambient Temperature (Typical)

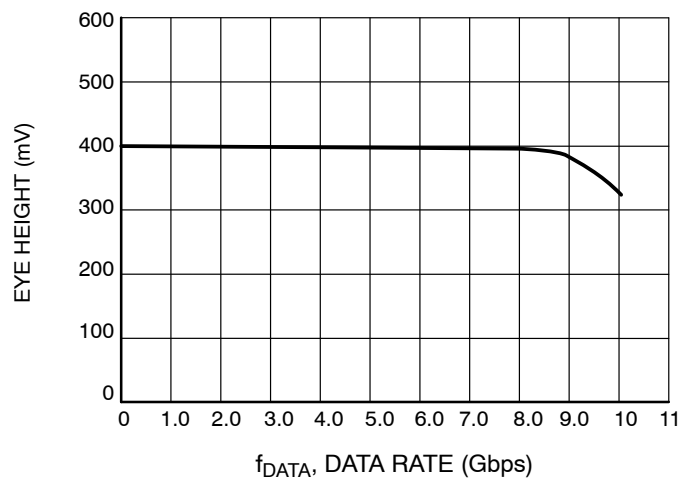


Figure 4. Inside Eye Height vs. Input Data Rate (Gbps) at Ambient Temperature (typical), FR4 = 12"

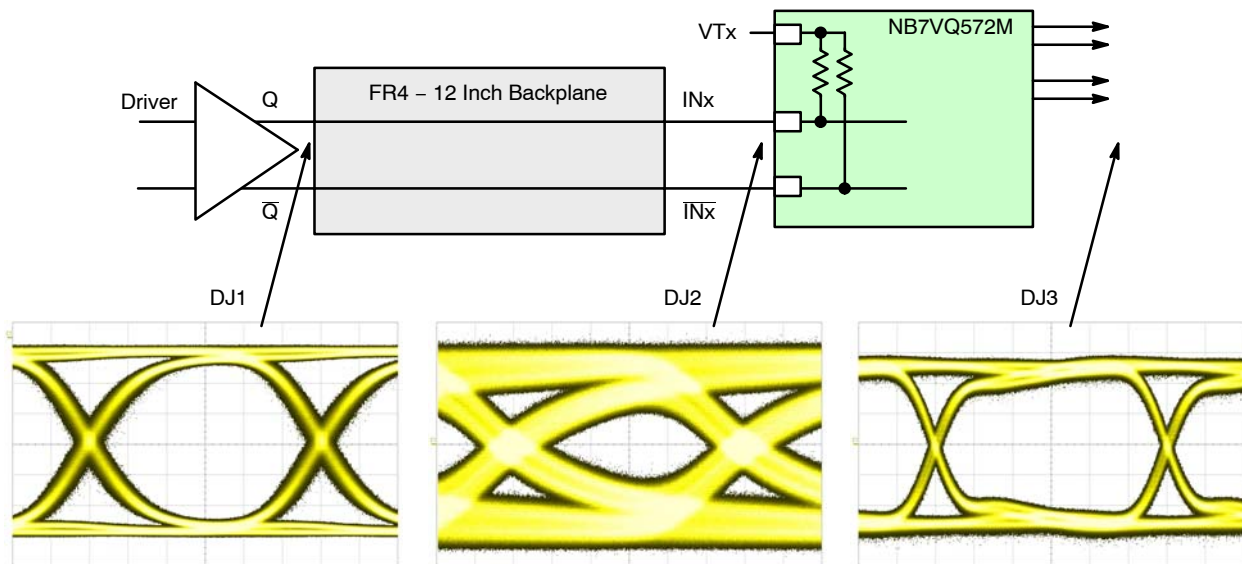


Figure 5. Typical NB7VQ572M Equalizer Application and Interconnect with PRBS23 Pattern at 10 Gbps

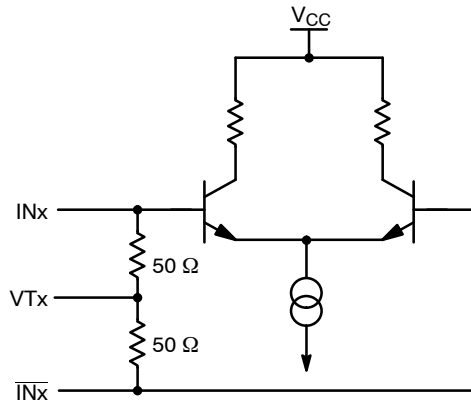


Figure 6. Input Structure

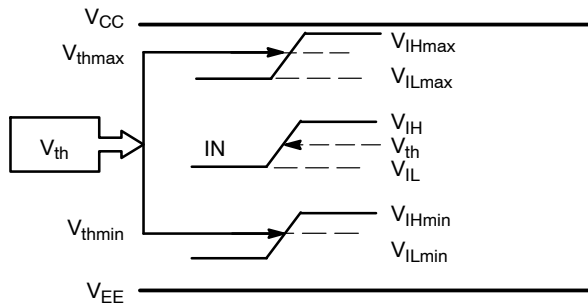


Figure 8. V_{th} Diagram

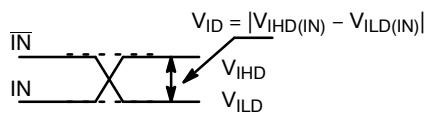


Figure 10. Differential Inputs Driven Differentially

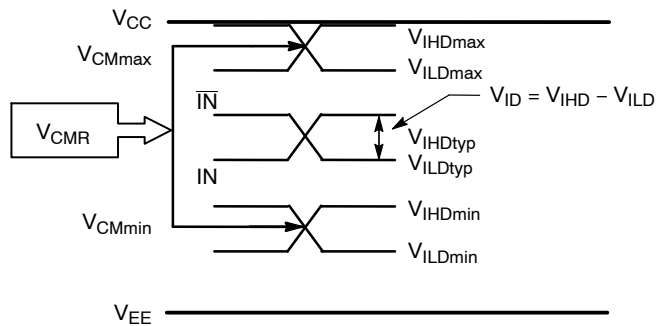


Figure 11. V_{CMR} Diagram

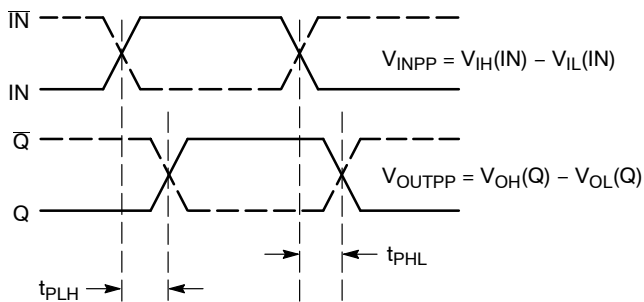


Figure 12. AC Reference Measurement

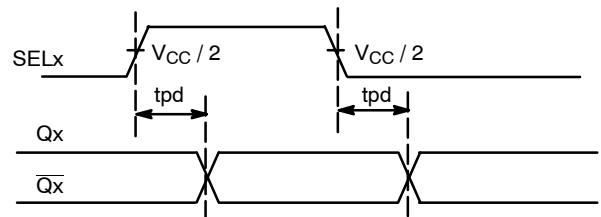


Figure 13. SELx to Qx Timing Diagram

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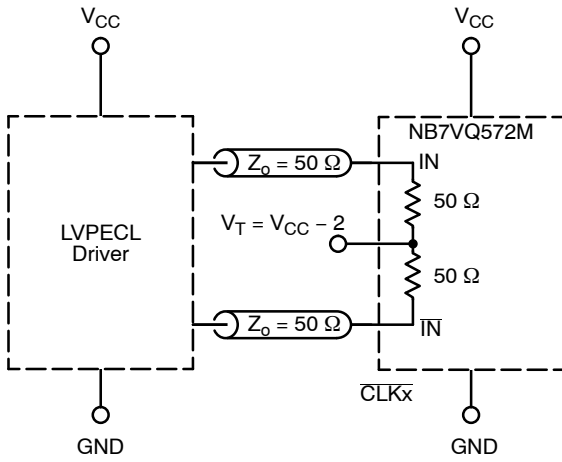


Figure 14. LVPECL Interface

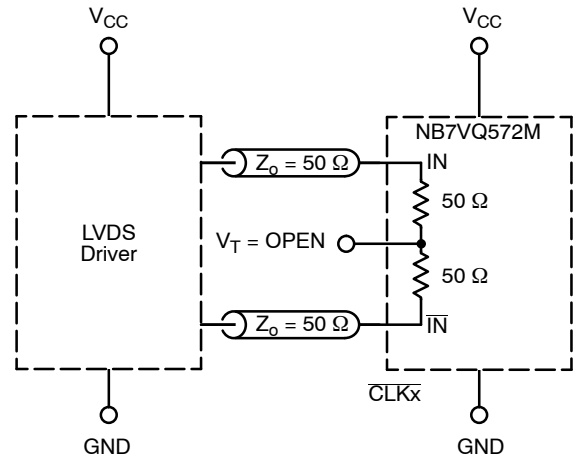


Figure 15. LVDS Interface

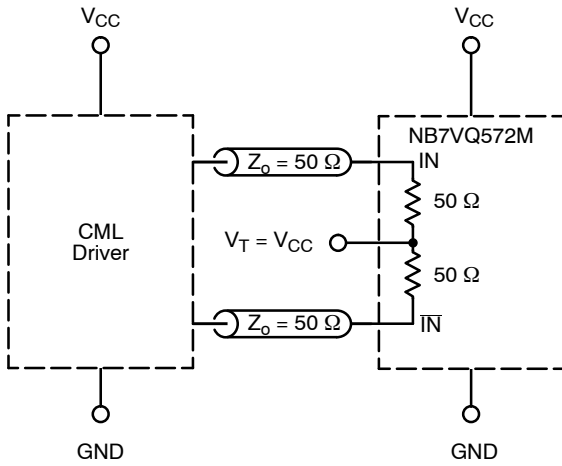


Figure 16. Standard 50 Ω Load CML Interface

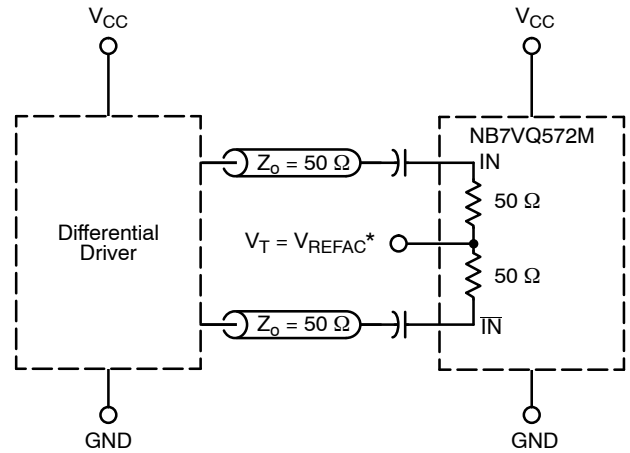


Figure 17. Capacitor-Coupled Differential Interface (V_T Connected to V_{REFAC})

* V_{REFAC} bypassed to ground with a 0.01 μ F capacitor.

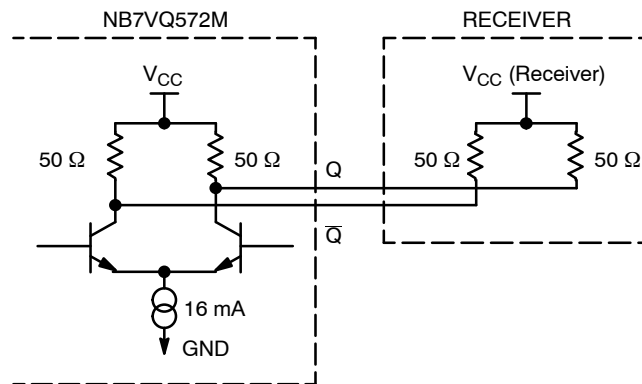


Figure 18. Typical CML Output Structure and Termination

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DEVICE ORDERING INFORMATION

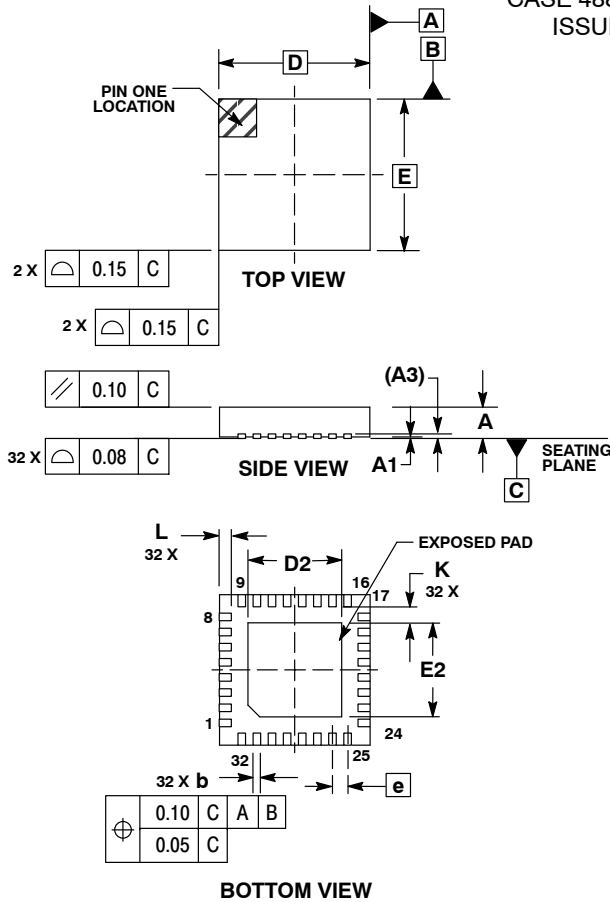
Device	Package	Shipping [†]
NB7VQ572MMNG	QFN-32 (Pb-free)	74 Units / Rail
NB7VQ572MMNR4G	QFN-32 (Pb-free)	1000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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PACKAGE DIMENSIONS

QFN32 5*5*1 0.5 P
CASE 488AM-01
ISSUE O

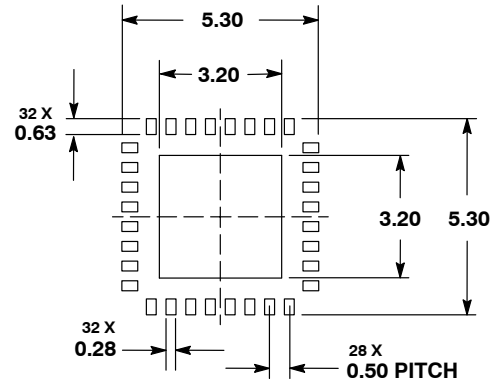


NOTES:

1. DIMENSIONS AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM TERMINAL.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

MILLIMETERS			
DIM	MIN	NOM	MAX
A	0.800	0.900	1.000
A1	0.000	0.025	0.050
A3	0.200 REF		
b	0.180	0.250	0.300
D	5.00 BSC		
D2	2.950	3.100	3.250
E	5.00 BSC		
E2	2.950	3.100	3.250
e	0.500 BSC		
K	0.200	---	---
L	0.300	0.400	0.500

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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<http://moschip.ru/get-element>

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В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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